

**Harvatek Surface Mount CHIP LEDs Approval Sheet
B2102USUG20C000133E0118**

Official Product	HT Part No. B2102USUG20C000133E0118		
Tentative Product	*****	*****	
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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specification

	Specification	Material	Quantity
Luminous Intensity(Iv)	US:45.0-180.0 mcd UG:28.5-180.0 mcd @20mA/ T _s = 25°C;Tolerance: ± 10%		
Wavelength	US: 615.0-630.0 nm UG : 567.5-579.5 nm @20mA/ T _s = 25°C;Tolerance: ± 0.5nm		
Vf	US: 1.6-2.4 V UG: 1.6-2.4 V @20mA/ T _s = 25°C ;Tolerance: ± 0.05V		
Ir	< 10 μA @ V _R = 5 V		
Resin	Clear	Epoxy resin	
Carrier tape	According to EIA 481-1A specs	Conductive tape	3000pcs per reel
Reel	According to EIA 481-1A specs	Plastic/ White	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel one bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note :This is shipped test conditions

※Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection

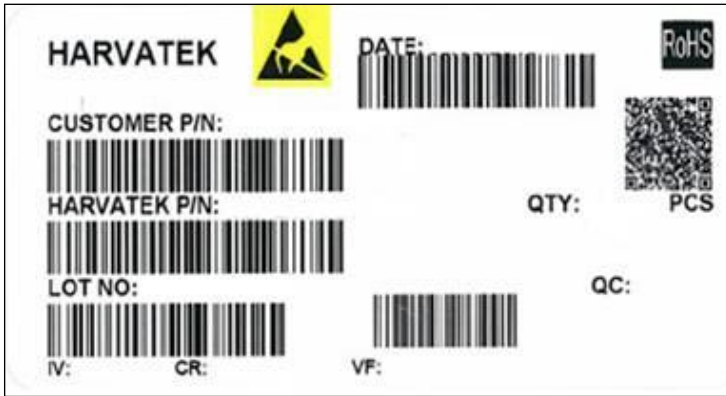


The symbol shown on the page herein to introduce 'Electro-Optical Characteristics'. ESD protection for GaP and AlGaAs based chips is still necessary even though they are safe in low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD protection has to considered and taken in the initial design stage.

If manual work/process is needed, please ensure the device is well protected from ESD during all the process.

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Label Spec.:



Customer P/N:

B 210 2 USUG 20C- 0001 33

Product	Package	Dice Q'ty	Color	Current	Series Number	Taping
PCB	3.2(L)x1.5(W)x1.0(H) mm	2: Bi	US: Ultra Bright Red UG: Ultra Bright Yellow Green	20mA	X001~XZZZ	1.Taping style 2. Q'ty

Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	A	1	A	2	2	L	1	2
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecutive number		Special code		
Internal Tracing Code		2020-L 2021-M 2022-P 2023-Q ... 2026-T 2027-V ... 2030-Y 2031-Z ...	1:Jan. 2:Feb. ... A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C ... 26:Z 27:7 28:8 29:9 30:3 31:4	01~ZZ		000~ZZZ		

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Product specifications

■ **Luminous Intensity (Iv) Bin:**

Color	Bin Code	Spec. Range
US	P	45.00-71.50 mcd
	Q	71.50-112.5 mcd
	R	112.5-180.0 mcd
UG	N	28.50-45.00 mcd
	P	45.00-71.50 mcd
	Q	71.50-112.5 mcd
	R	112.5-180.0 mcd

Note: It maintains a tolerance of $\pm 10\%$ on luminous intensity

■ **Wavelength Bin:**

Color	Bin Code	Spec. Range
US	AC	615.0-630.0 nm
UG	C	567.5-570.5 nm
	D	570.5-573.5 nm
	E	573.5-576.5 nm
	F	576.5-579.5 nm

Note: It maintains a tolerance of $\pm 0.5\text{nm}$ on Wavelength Bin

■ **Forward Voltage (Vf) Bin:**

Color	Bin Code	Spec. Range
US	E18	1.6-2.4 V
UG	E18	1.6-2.4 V

Note: It maintains a tolerance of $\pm 0.05\text{V}$ on forward voltage measurements

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Product Feature

Electro-Optical Characteristics

(T_{Soldering} 25 °C)

Series	Emitting Color	Material	V _F (V)		Wavelength λ(nm)			I _v (mcd)	Viewing Angle
			typ	max	λ _D	λ _P	Δλ	Typical	2θ ^{1/2}
B2102USUG20	US	AlGaInP	2.0	2.4	624	632	20	112.5	X=130 Y=100
	UG	AlGaInP	2.1	2.4	571	573	15	71.5	X=124 Y=115

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

Unit: mm Tolerance: +/-0.1

Outline Dim.	Suggest Soldering Pattern
Soldering terminal may shift in x, y direction.	

Absolute Maximum Ratings

(T_{Soldering} 25 °C)

Series	P _D (mW)	I _F (mA)	I _{FP} (mA)*	T _{OP} (°C)	T _{ST} (°C)
Color	Power Dissipation	Forward Current	Pulse Forward Current	Operating Temperature	Storage Temperature
US	48	20	100	-40~+85	-40~+100
UG	48	20	100	-40~+85	-40~+100

*Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

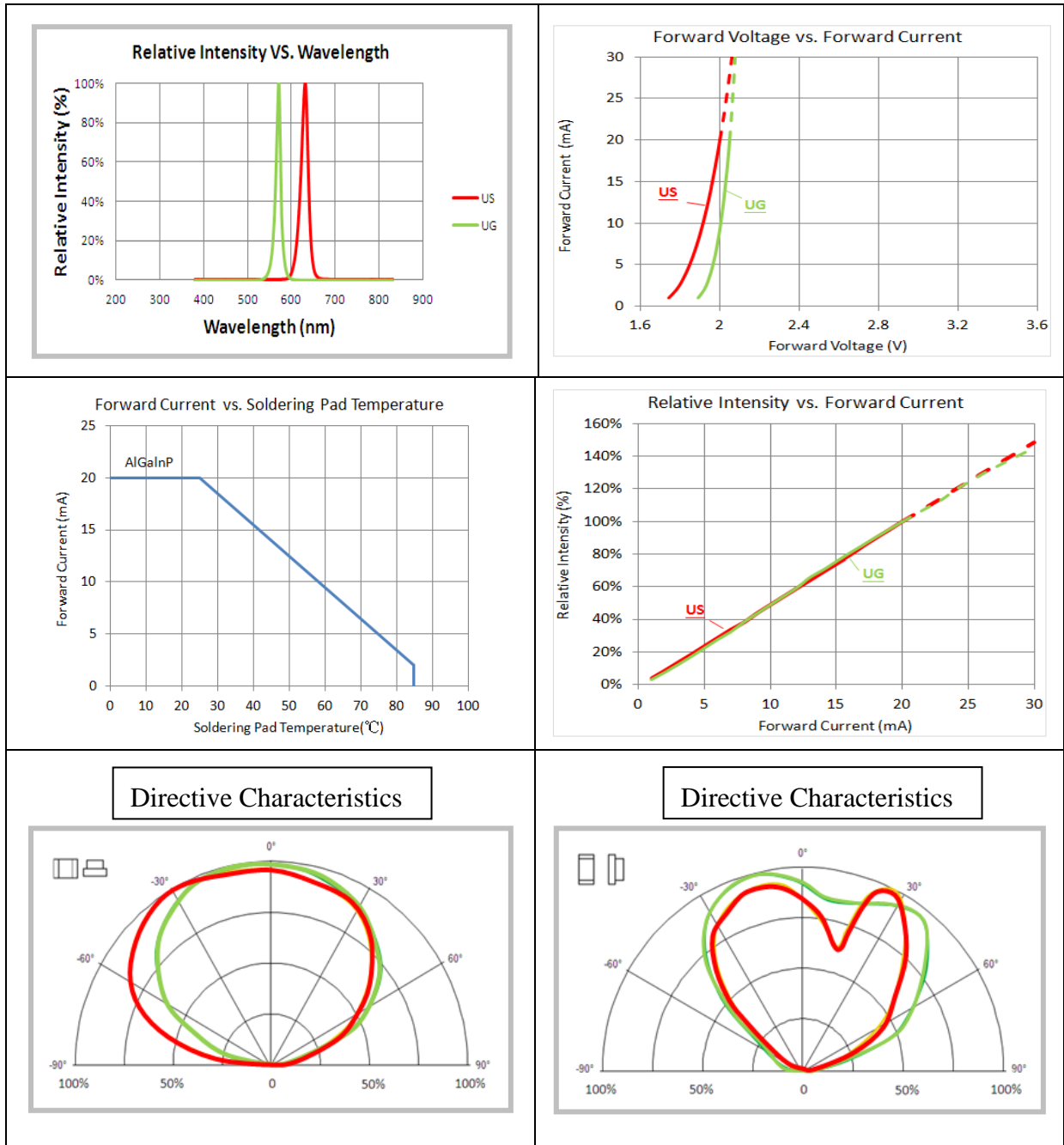
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Precaution for Use

1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
5. The appearance and specifications of the products may be modified for improvement without further notice.
6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

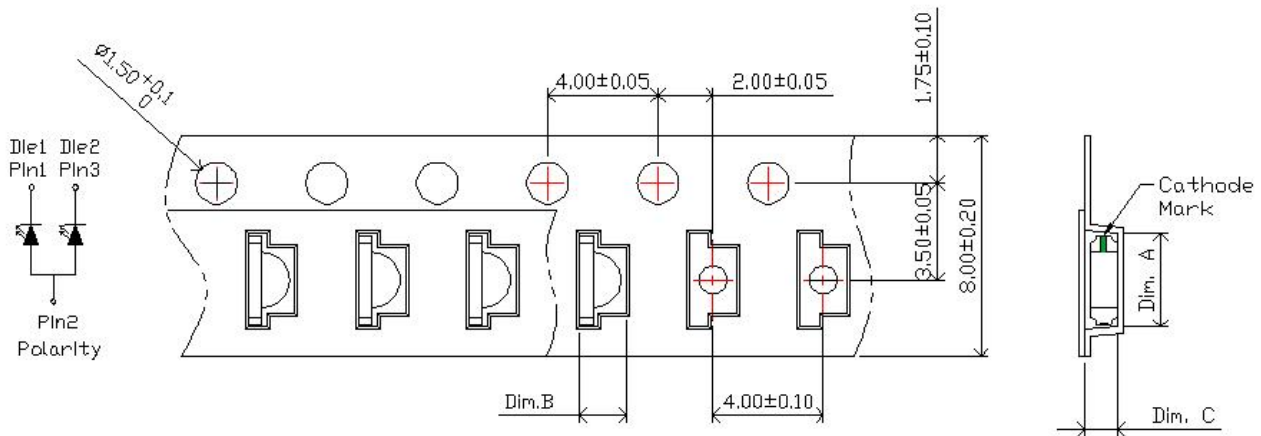
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Characteristics of B2102USUG

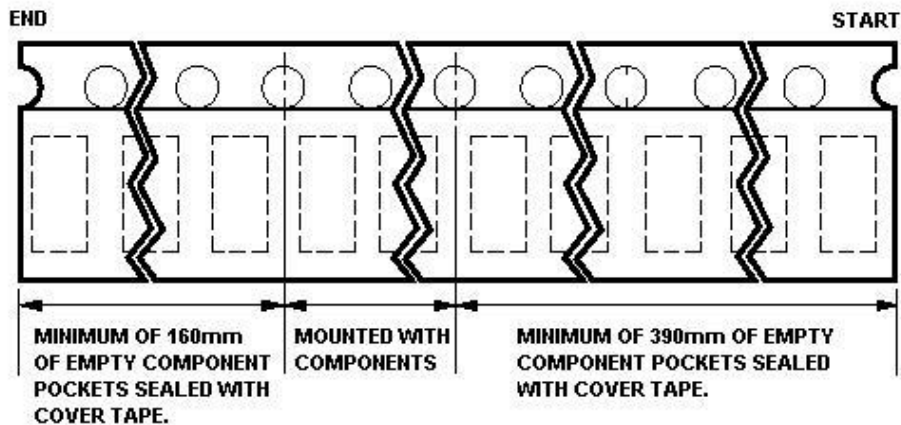


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Packaging Tape, Reel, and Packing Model Tape Dimension

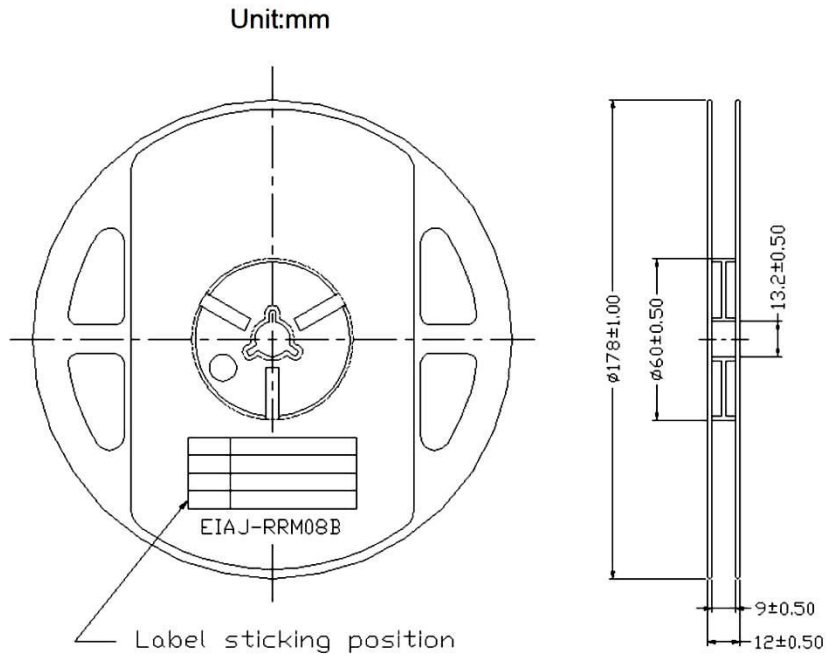


Dim. A	Dim. B	Dim. C	Q'ty/Reel
3.40 ± 0.10	1.70 ± 0.10	1.20 ± 0.10	3K

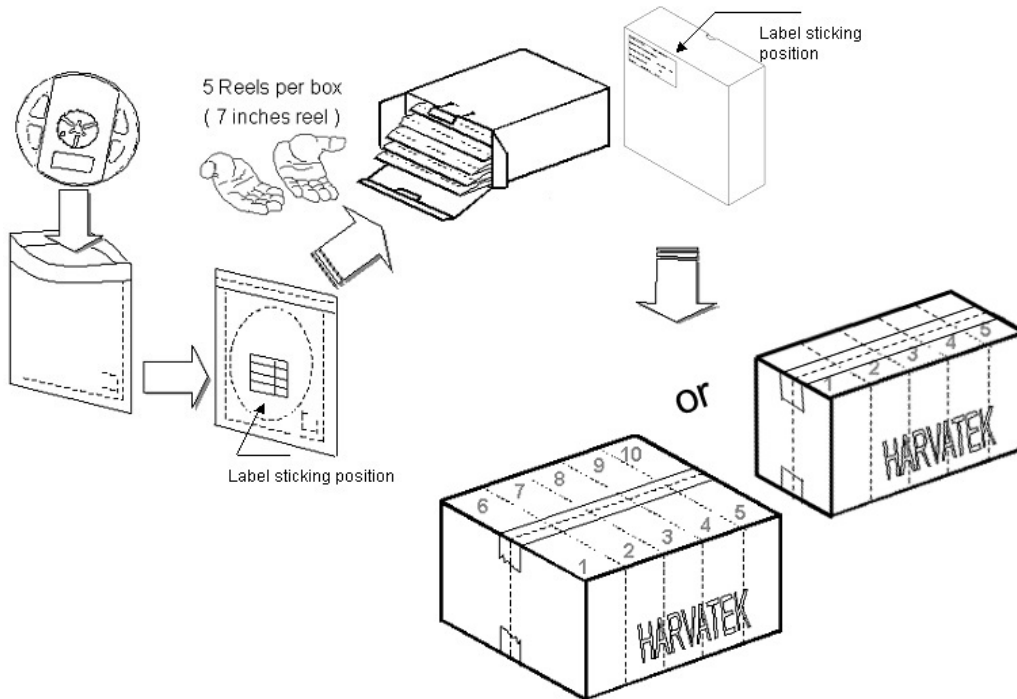


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Reel Dimension



Packing



5 or 10 boxes per carton is available depending on shipment quantity.

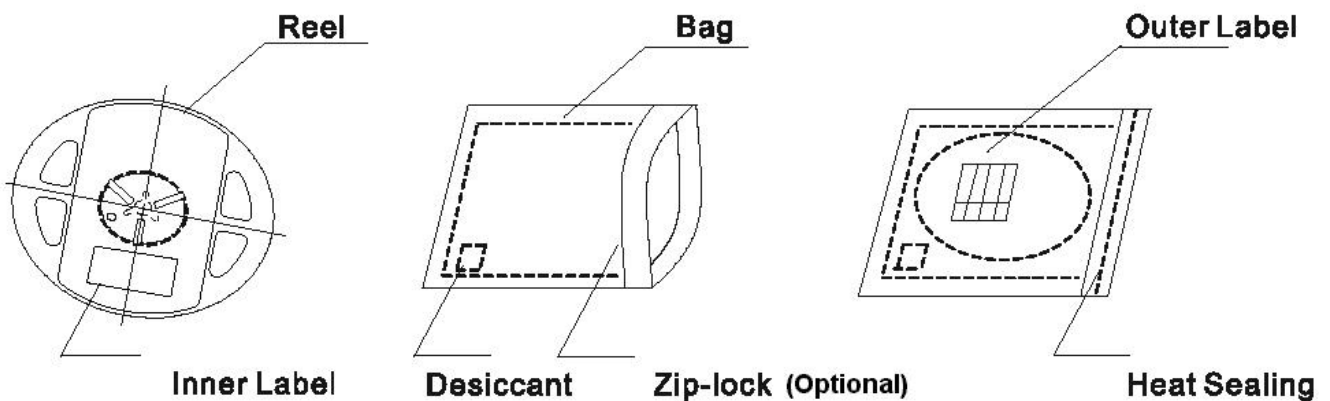
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Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 4 weeks.

The conditions are as followings:

1. 60±3°C x(12~24hrs)and<5%RH, taped reel type.
2. 100±3°C x(45min~1hr), bulk type.
3. 130±3°C x(15min~30min), bulk type.

Precautions

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

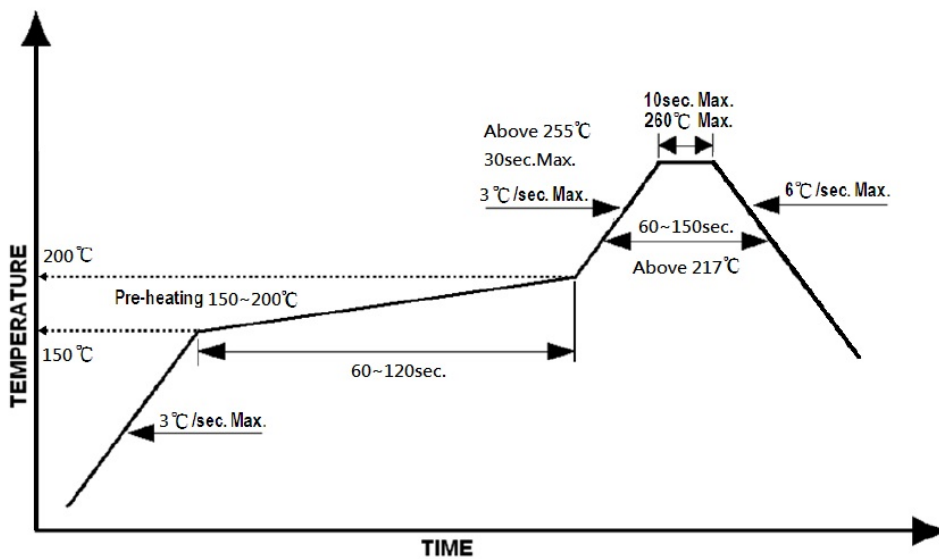
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Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 217°C ,60~150 sec.
2. Peak temp.:260 °C Max.,10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never attempt next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

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